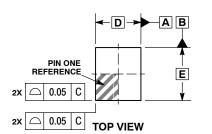
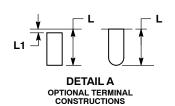
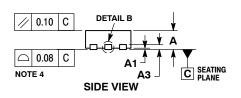


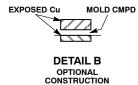
UDFN6 1.2x1.4, 0.4P CASE 517CW **ISSUE O**

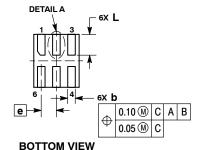
DATE 09 JAN 2014











- IOTES.

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION 5 APPLIES TO PLATED TERMINAL AND
- IS MEASURED BETWEEN 0.15 AND 0.25MM FROM THE TERMINAL TIP.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
A3	0.13 REF		
b	0.15	0.25	
D	1.20 BSC		
Е	1.40 BSC		
е	0.40 BSC		
L	0.50	0.60	
L1		0.15	

GENERIC MARKING DIAGRAM*

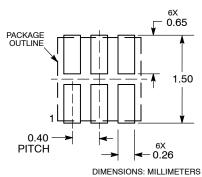


Х = Specific Device Code

= Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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